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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MING GONG	11/23/2015
JIN DAI	11/23/2015
HAO CUI	11/23/2015
XIAODONG WANG	11/23/2015
HAN HUANG	11/23/2015
JUN WU	11/30/2015
WEI FAN	11/23/2015
NING MA	11/30/2015
XINHUA RONG	11/23/2015
XINGSEN LIN	11/23/2015

RECEIVING PARTY DATA

Name:	SZ DJI TECHNOLOGY CO., LTD.
Street Address:	17/F WEST WING SKYWORTH SEMICONDUCTOR DESIGN BLDG., NO. 18 GAOXIN SOUTH 4TH AVENUE, NANSHAN DISTRICT
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518057

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15862845

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 00203.1214.04US

PATENT REEL: 044542 FRAME: 0833

NAME OF SUBMITTER:	HOI CHEUNG
SIGNATURE:	/Hoi Cheung/
DATE SIGNED:	01/05/2018
Total Attachments: 2	

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> **PATENT** REEL: 044542 FRAME: 0834

Docket Number 45236-773.303 PATENT ASSIGNMENT WHEREAS, the undersigned: 3. CUI, Hao 4. WANG, Xinodong 1. GONG, Ming 2. DAI, Jin Shonzhen City, China Shenzhen City, China Shenzhen City, China Shenzhen City, China 5. HUANG, Han 6. WU, Jun 7. FAN. Wei 8. MA. Ning Shenzhen City, China Shenzhan City, China Shenzhen City, China Sitenzhen City, China 9. RONO, Xinhua 10, LIN, Xingsen

Shenzhen City, China (hereinafter "Inventor(s))," have invented certain new and useful improvements in

Shenzhen City, China

AUTHENTICATION SYSTEMS AND METHODS FOR GENERATING FLIGHT REGULATIONS

for which application scrial number 14/942,936 was filed on November 16, 2015 in the United States Patent and Trademark Office; (hereinafter, "Application(s)"). The term "Application(s)" also includes all patent applications that share or claim priority to or from the above

WHEREAS, SZ DJ1 TECHNOLOGY CO., LTD, a corporation of the Commonwealth of Chinn, having a place of business at 17/F. West Wing. Skyworth Semiconductor Design Building, No. 18 Gaoxin South 4th Avenue, Naushan District, Shenzhen City, China 518057, (hereinafter "Assignee"), is desirous of acquiring the entire right, title and interest in and to said Application(s), and the inventions disclosed therein, and in and to all embodiments of the inventions, heretofore conceived, made or discovered, whether jointly or severally, by said inventor(s) (hereinafter collectively referred to us "inventions"), and in and to any and all patents, inventor's certificates and other forms of protection thereon granted in the United States, foreign countries, or under any international convention, agreement, protocol, or treaty, including those filed under the Paris Convention for the Protection of Industrial Property, The Patent Cooperation Treaty or otherwise (hereinafter "Patent(s)").

NOW. THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor(s) to have been received in full from suid Assignce:

- 1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said Inventions; (b) in and to said Applications, including the right to claim priority to and from said Application(s); (c) in and to each and every application that is a divisional, substitution, continuation, or continuation-in-part of any of soid Application(s); (d) in and to said Patent(s) and each and every patent issuing or reissuing from any of the foregoing; (e) in and to each and every reissue, reexamination, renewal or extension of any kind of any of the foregoing; (f) in and to each and every patent and application filed outside the United States and corresponding to any of the foregoing; and(g) in and to all claims for past. present and future infringement of the Patent(s), including all rights to sue for and to receive and recover for Assignce's own use all past, present, and future lust profits, royalties, and thinniges of whatever nature recoverable from an infringement of the Patent(s).
- 2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignce to enable said Assignce to enjoy to the Italiest extent the right, title and interest herein conveyed in the United States, foreign countries, or under any international convention, agreement, protocol, or treaty. Such cooperation by said inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any applications covering said inventions; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said inventions; (d) for filing and prosecuting applications for reissuance of any said Patent(s); (e) for interference or other priority proceedings involving said inventions; and (f) for logal proceedings involving said inventions and any applications therefor and any Patent(s) granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that reasonable expenses incurred by said inventor(s) in providing such cooperation shall be paid for by said Assignes.
- The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said inventor(s), their respective heirs, legal representatives and assigns.
- Said inventor(s) hereby warrant, represent and covenant that said inventor(s) have not entered and will not onter into any assignment, contract, or understanding in conflict herewith.
- Said Inventor(s) hereby request that any Patent(s) issuing in the United States, foreign countries, or under any international convention, agreement, protocol, or treaty, be issued in the name of the Assignee, or its successors and assigns, for the sole use of said Assignee, its successors, legal representatives and assigns.
- This instrument will be interpreted and construed in accordance with the laws of the State of California, without regard to conflict of law principles. If any provision of this instrument is found to be illegal or unenforceable, the other provisions shall remain effective and enforceable to the greatest extent permitted by law. This instrument may be executed in counterparts, each of which is deemed no original, but all of which together constitute one and the same agreement.

IN WITNESS WHEREOF, said Inventorial have executed and delivered this instrument to said Assignce as of the dates written below:			
Date: 1/23/2015	Ming Grong	Dale: 2015.11.23	Jin Dai
Date: 2015. 1 1.73	Hadcul	Dute: 2015.11.23	Warg Kinodong Xinodong Wang

PATENT ASSIGNMENT		Docket Number 45236-773.303
Date: 2015.11.23 [Am 14]	Date: 2015.(1.3°	Wn Jun
11/.: P	Date: 2015.11.30 N	Ning Ma
Date: Nov 23, 201) Xinhua Rong Xinhua Rong	Date: 2015, (1,2)	Kingson Lin

PATENT REEL: 044542 FRAME: 0836

RECORDED: 01/05/2018